

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V <sub>CC</sub>	-50V
$I_{C(MAX.)}$	-100mA
R <sub>1</sub>	22kΩ
R <sub>2</sub>	22kΩ

#### Features

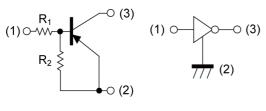
- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 22k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC124E series

## Application

INVERTER, INTERFACE, DRIVER

#### •Inner circuit

DTA124EM/ DTA124EEB/ DTA124EUB

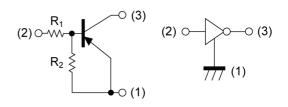


- (1) IN (BASE)
- (2) GND (+) (EMITTER)
- (3) OUT (COLLECTOR)

### Outline

- Oddinic	
SOT-723	SOT-416FL (3)
DTA124EM	DTA124EEB
(VMT3)	(EMT3F)
SOT-416	SOT-323FL
DTA124EE	DTA124EUB
(EMT3)	(UMT3F)
SOT-323	SOT-346
(2)	(2)
DTA124EUA	DTA124EKA
(UMT3)	(SMT3)

### DTA124EE/ DTA124EUA/ DTA124EKA



- (1) GND (+) (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA124EM	SOT-723	1212	T2L	180	8	8000	15
DTA124EEB	SOT-416FL	1616	TL	180	8	3000	15
DTA124EE	SOT-416	1616	TL	180	8	3000	15
DTA124EUB	SOT-323FL	2021	TL	180	8	3000	15
DTA124EUA	SOT-323	2021	T106	180	8	3000	15
DTA124EKA	SOT-346	2928	T146	180	8	3000	15

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## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Para	ameter	Symbol	Values	Unit
Supply voltage			-50	V
Input voltage			-40 to 10	V
Output current		Io	-30	mA
Collector current			-100	mA
	DTA124EM		150	mW
	DTA124EEB		150	
Davis a dia sia atia a	DTA124EE	D *2	150	
Power dissipation	DTA124EUB	P <sub>D</sub> *2	200	
	DTA124EUA		200	
	DTA124EKA		200	
Junction temperature			150	°C
Range of storage temperature	re	T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Dougnoston	C: resh al	Conditions	Values			l lm:4
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
land to take a	$V_{l(off)}$	$V_{CC} = -5V, I_{O} = -100\mu A$	-	-	-0.5	\/
Input voltage	V <sub>I(on)</sub>	$V_O = -0.2V$ , $I_O = -5mA$	-3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -10mA, I <sub>I</sub> = -0.5mA	-	-100	-300	mV
Input current	I <sub>I</sub>	V <sub>I</sub> = -5V	-	-	-360	μA
Output current	I <sub>O(off)</sub>	$V_{CC} = -50V, V_{I} = 0V$	-	-	-500	nA
DC current gain	G <sub>I</sub>	$V_{O} = -5V, I_{O} = -5mA$	56	-	-	-
Input resistance	R <sub>1</sub>	-	15.4	22	28.6	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	8.0	1.0	1.2	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Characteristics of built-in transistor

<sup>\*2</sup> Each terminal mounted on a reference land.

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

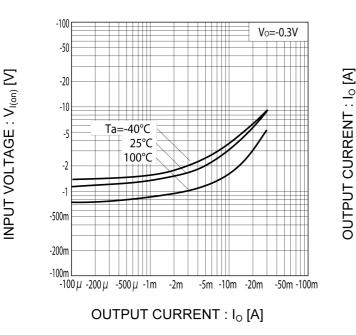


Fig.2 Output current vs. input voltage (OFF characteristics)

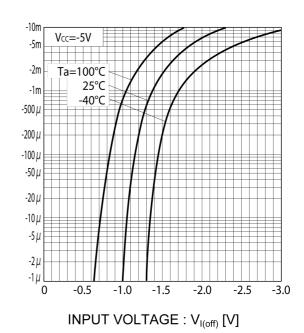


Fig.3 Output current vs. output voltage

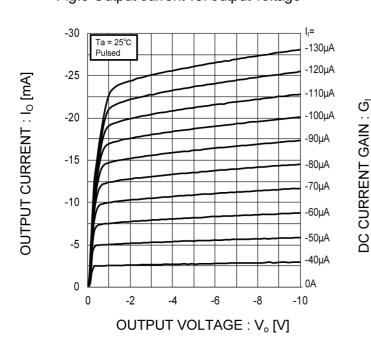
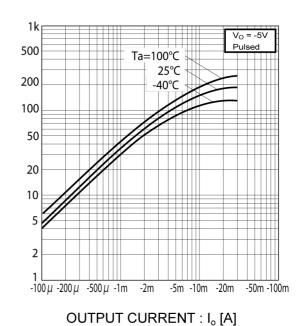
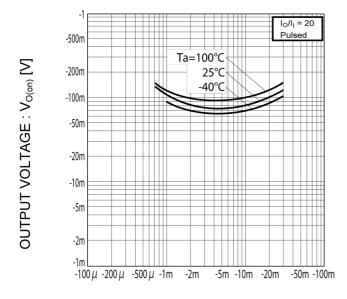


Fig.4 DC current gain vs. output current

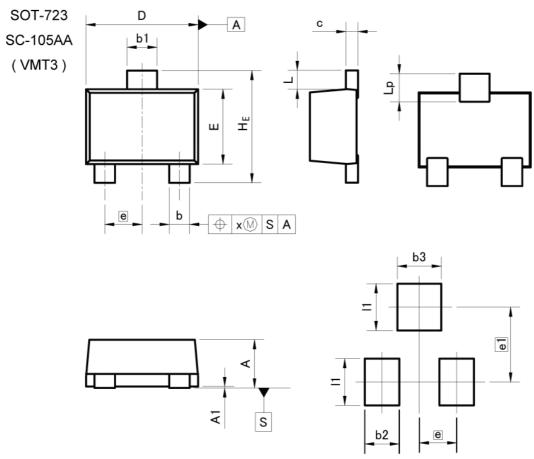


## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : Io [A]



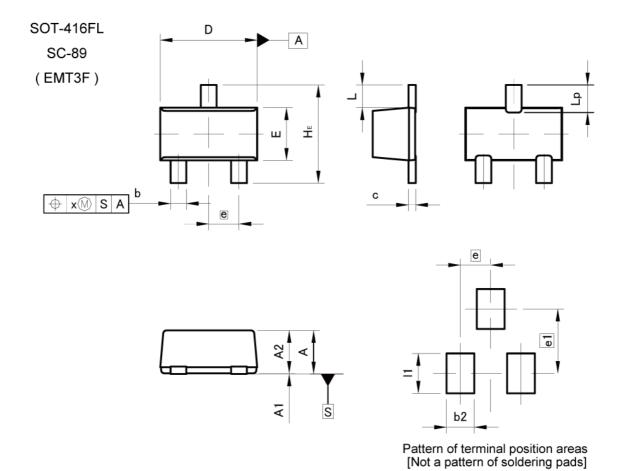
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	-	0.10	_	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	_	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	=	0.50	- 0.020	

Dimension in mm/inches



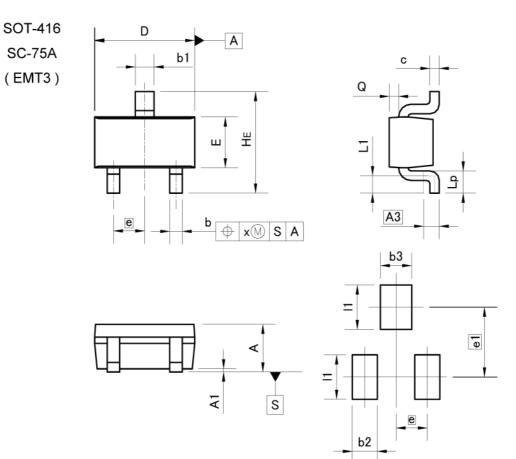


DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
Х	<u> </u>	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	_	0.46	_	0.018	
e1	_	1.05	-	0.041	
- 11	-	0.65	-	0.026	

Dimension in mm/inches





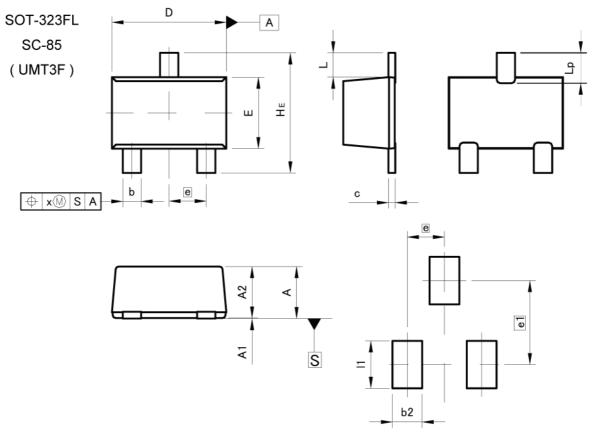
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15		0.006	% <del>-</del>
Q	0.05	0.25	0.002	0.010
х	\ <del>-</del>	0.10	, <del>-</del> ,	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	I	0.50	-	0.020
e1	1.10		0.0	143
l1	i -	0.70	-	0.028

Dimension in mm/inches





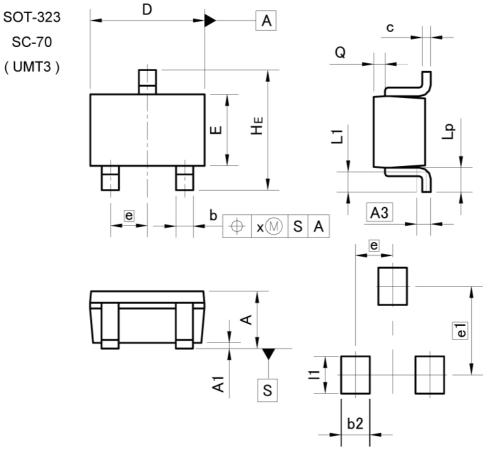
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.0	26
HE	2.00	2.20	0.079	0.087
L	0.4	43	0.0	17
Lp	0.43	0.63	0.017	0.025
х	_	0.10	-	0.004

	DIM	MILIMETERS		INCHES	
		MIN	MAX	MIN	MAX
	b2	-	0.52	ı	0.020
	e1	1.47		0.058	
	l1	- 0.83		=	0.033

Dimension in mm/inches





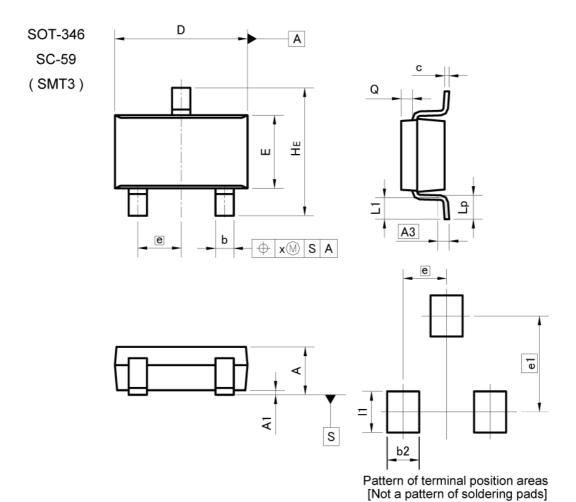
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0	0.004	
A3	0.25		0.01		
b	0.25	0.40	0.01	0.016	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.0	0.65		0.03	
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.02	
Lp	0.25	0.55	0.01	0.022	
Q	0.10	0.30	0.004	0.012	
х	_	0.10	_	0.004	

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
e1	1.55		0.06	
b2	- 0.50		1	0.02
11	_	0.65	_	0.026

Dimension in mm/inches





DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-	0.10	e=	0.004
у	- >	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIW	MIN	MAX	MIN	MAX	
b2	-	0.60	_	0.024	
e1	2.	2.10		0.083	
- 11	-3	0.90	-	0.035	

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA
CLASSIII	от 400 ш	CLASS II b	ОГУССШ
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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
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- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Rev.001

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NSBC114YF3T5G NSBC123TF3T5G SMUN5235T1G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F)

RN4605(TE85L,F) TTEPROTOTYPE79 DDTC114EUAQ-7-F EMH15T2R SMUN2214T3G NSBC114TF3T5G NSBC143ZPDP6T5G

NSVMUN5113DW1T3G SMUN5230DW1T1G SMUN5133T1G SMUN2214T1G DTC114EUA-TP NSBA144EF3T5G

NSVDTA114EET1G 2SC2223-T1B-A 2SC3912-TB-E SMUN5237DW1T1G SMUN5213DW1T1G SMUN5114DW1T1G SMUN2111T1G

NSVDTC144EM3T5G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTA113EM3T5G DCX115EK-7-F DTC113EM3T5G

NSVMUN5135DW1T1G NSVMUN2237T1G NSVDTC143ZM3T5G